

Technische Information/technical information

IGBT-Module
IGBT-modules

FD800R33KF2C-K



Vorläufige Daten
preliminary data

IGBT-Wechselrichter/IGBT-inverter

Höchstzulässige Werte/maximum rated values

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = -25^{\circ}\text{C}$	V_{CES}	3300 3300	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}$	$I_{C\ nom}$ I_C	800 1300	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_P = 1\ \text{ms}, T_C = 80^{\circ}\text{C}$	I_{CRM}	1600	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^{\circ}\text{C}$	P_{tot}	9,60	kW
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/-20	V

Charakteristische Werte/characteristic values

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$I_C = 800\ \text{A}, V_{GE} = 15\ \text{V}, T_{vj} = 25^{\circ}\text{C}$ $I_C = 800\ \text{A}, V_{GE} = 15\ \text{V}, T_{vj} = 125^{\circ}\text{C}$	$V_{CE\ sat}$	3,40 4,30	4,25 5,00		V V
Gate-Schwellenspannung gate threshold voltage	$I_C = 80,0\ \text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	V_{GEth}	4,2	5,1	6,0	V
Gateladung gate charge	$V_{GE} = -15\ \text{V} \dots +15\ \text{V}, V_{CE} = 1800\ \text{V}$	Q_G		15,0		μC
Interner Gatewiderstand internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}		0,63		Ω
Eingangskapazität input capacitance	$f = 1\ \text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$	C_{ies}		100		nF
Rückwirkungskapazität reverse transfer capacitance	$f = 1\ \text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$	C_{res}		5,40		nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{CE} = 3300\ \text{V}, V_{GE} = 0\ \text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			5,0	mA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\ \text{V}, V_{GE} = 20\ \text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			400	nA
Einschaltverzögerungszeit (ind. Last) turn-on delay time (inductive load)	$I_C = 800\ \text{A}, V_{CE} = 1800\ \text{V}$ $V_{GE} = \pm 15\ \text{V}, R_{Gon} = 1,4\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\ \text{V}, R_{Gon} = 1,4\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 125^{\circ}\text{C}$	$t_{d\ on}$		0,28 0,28		μs μs
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 800\ \text{A}, V_{CE} = 1800\ \text{V}$ $V_{GE} = \pm 15\ \text{V}, R_{Gon} = 1,4\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\ \text{V}, R_{Gon} = 1,4\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 125^{\circ}\text{C}$	t_r		0,18 0,20		μs μs
Abschaltverzögerungszeit (ind. Last) turn-off delay time (inductive load)	$I_C = 800\ \text{A}, V_{CE} = 1800\ \text{V}$ $V_{GE} = \pm 15\ \text{V}, R_{Goff} = 1,8\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\ \text{V}, R_{Goff} = 1,8\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 125^{\circ}\text{C}$	$t_{d\ off}$		1,55 1,70		μs μs
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 800\ \text{A}, V_{CE} = 1800\ \text{V}$ $V_{GE} = \pm 15\ \text{V}, R_{Goff} = 1,8\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\ \text{V}, R_{Goff} = 1,8\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 125^{\circ}\text{C}$	t_f		0,20 0,20		μs μs
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = 800\ \text{A}, V_{CE} = 1800\ \text{V}, L_S = 40\ \text{nH}$ $V_{GE} = \pm 15\ \text{V}, R_{Gon} = 1,4\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\ \text{V}, R_{Gon} = 1,4\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 125^{\circ}\text{C}$	E_{on}		930 1450		mJ mJ
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = 800\ \text{A}, V_{CE} = 1800\ \text{V}, L_S = 40\ \text{nH}$ $V_{GE} = \pm 15\ \text{V}, R_{Goff} = 1,8\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\ \text{V}, R_{Goff} = 1,8\ \Omega, C_{GE} = 150\ \text{nF}, T_{vj} = 125^{\circ}\text{C}$	E_{off}		870 1000		mJ mJ
Kurzschlußverhalten SC data	$t_P \leq 10\ \mu\text{s}, V_{GE} \leq 15\ \text{V}$ $T_{vj} \leq 125^{\circ}\text{C}, V_{CC} = 2500\ \text{V}, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	I_{sc}		4000		A
Innerer Wärmewiderstand thermal resistance, junction to case	pro IGBT per IGBT	R_{thJC}			13,0	K/kW
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro IGBT / per IGBT $\lambda_{Paste} = 1\ \text{W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1\ \text{W}/(\text{m}\cdot\text{K})$	R_{thCH}		8,00		K/kW



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Diode-Wechselrichter/diode-inverter

Höchstzulässige Werte/maximum rated values

Periodische Spitzensperrspannung repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = -25^{\circ}\text{C}$	V_{RRM}	3300 3300	V
Dauergleichstrom DC forward current		I_F	800	A
Periodischer Spitzenstrom repetitive peak forward current	$t_P = 1 \text{ ms}$	I_{FRM}	1600	A
Grenzlastintegral I^2t - value	$V_R = 0 \text{ V}$, $t_P = 10 \text{ ms}$, $T_{vj} = 125^{\circ}\text{C}$	I^2t	220	kA^2s
Spitzenverlustleistung maximum power dissipation	$T_{vj} = 125^{\circ}\text{C}$	P_{RQM}	1600	kW
Mindesteinschaltdauer minimum turn-on time		$t_{Fon \text{ min}}$	10,0	μs

Charakteristische Werte/characteristic values

			min.	typ.	max.	
Durchlassspannung forward voltage	$I_F = 800 \text{ A}$, $V_{GE} = 0 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $I_F = 800 \text{ A}$, $V_{GE} = 0 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	V_F		2,80 2,80	3,50 3,50	V V
Rückstromspitze peak reverse recovery current	$I_F = 800 \text{ A}$, $-di_F/dt = 4500 \text{ A}/\mu\text{s}$ $V_R = 1800 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $V_R = 1800 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	I_{RM}		1100 1300		A A
Sperrverzögerungsladung recovered charge	$I_F = 800 \text{ A}$, $-di_F/dt = 4500 \text{ A}/\mu\text{s}$ $V_R = 1800 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $V_R = 1800 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	Q_r		500 900		μC μC
Abschaltenergie pro Puls reverse recovery energy	$I_F = 800 \text{ A}$, $-di_F/dt = 4500 \text{ A}/\mu\text{s}$ $V_R = 1800 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $V_R = 1800 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	E_{rec}		490 1150		mJ mJ
Innerer Wärmewiderstand thermal resistance, junction to case	pro Diode per diode	R_{thJC}			26,0	K/kW
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Diode / per diode $\lambda_{Paste} = 1 \text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$	R_{thCH}		16,0		K/kW

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Modul/module

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min.	V _{ISOL}	6,0		kV
Teilentladungs Aussetzspannung partial discharge extinction voltage	RMS, f = 50 Hz, Q _{PD} ≤ 10 pC (acc. to IEC 1287)	V _{ISOL}	2,6		kV
Kollektor-Emitter-Gleichsperrspannung DC stability	T _{vj} = 25°C, 100 fit	V _{CE D}	1800		V
Material Modulgrundplatte material of module baseplate			AlSiC		
Material für innere Isolation material for internal insulation			AlN		
Kriechstrecke creepage distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal		32,0 32,0		mm
Luftstrecke clearance distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal		19,0 19,0		mm
Vergleichszahl der Kriechwegbildung comparative tracking index		CTI	> 400		
			min.	typ.	max.
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module λ _{Paste} = 1 W/(m·K) / λ _{grease} = 1 W/(m·K)	R _{thCH}		4,00	K/kW
Modulinduktivität stray inductance module		L _{sCE}		12	nH
Modulleitungswiderstand, Anschlüsse - Chip module lead resistance, terminals - chip	T _C = 25°C, pro Zweig / per arm	R _{CC'+EE'} R _{AA'+CC'}		0,19 0,34	mΩ
Höchstzulässige Sperrschichttemperatur maximum junction temperature		T _{vj max}			150 °C
Temperatur im Schaltbetrieb temperature under switching conditions		T _{vj op}	-40		125 °C
Lagertemperatur storage temperature		T _{stg}	-40		125 °C
Anzugsdrehmoment f. mech. Befestigung mounting torque	Schraube / screw M6	M	4,25	-	5,75 Nm
Anzugsdrehmoment f. elektr. Anschlüsse terminal connection torque	Schraube / screw M4 Schraube / screw M8	M	1,8 8,0	- -	2,1 10 Nm
Gewicht weight		G		1500	g

Modulinduktivität: IGBT (Zweig1+2parallel): 12nH; Diode (Zweig3): 25nH
stray inductance module: IGBT (arm1+2parallel): 12nH; diode (arm3): 25nH

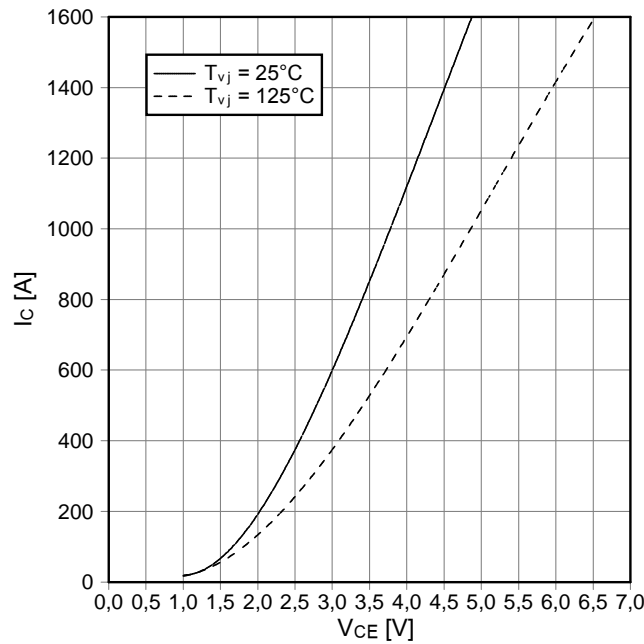
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This technical information specifies semiconductor devices but guarantees no characteristics. It is valid with the appropriate technical explanations.

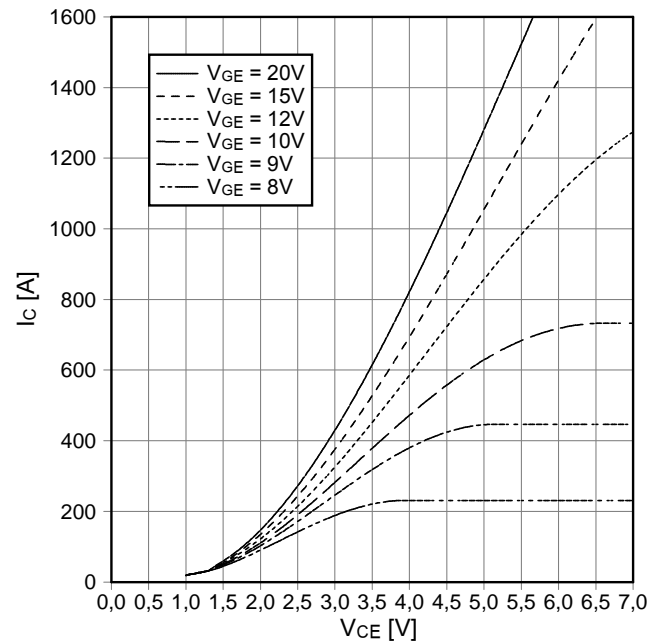
prepared by: Jürgen Biermann	date of publication: 2003-6-13
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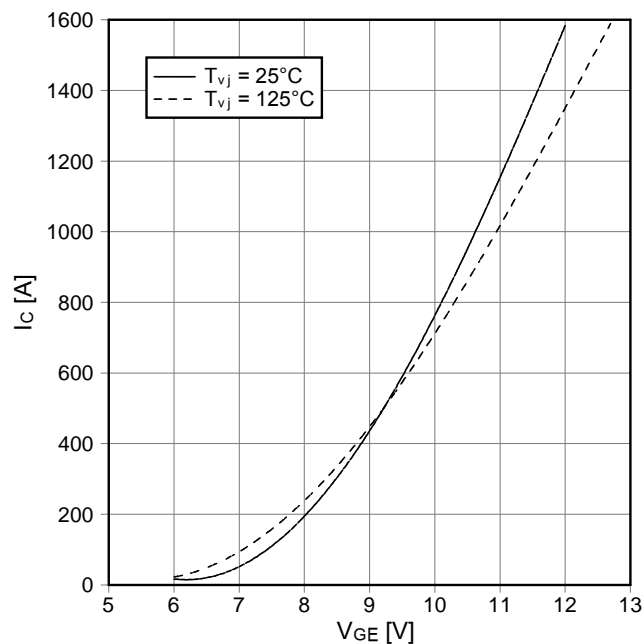
Ausgangskennlinie IGBT-Wechselr. (typisch)
output characteristic IGBT-inverter (typical)
 $I_c = f(V_{CE})$
 $V_{GE} = 15\text{ V}$



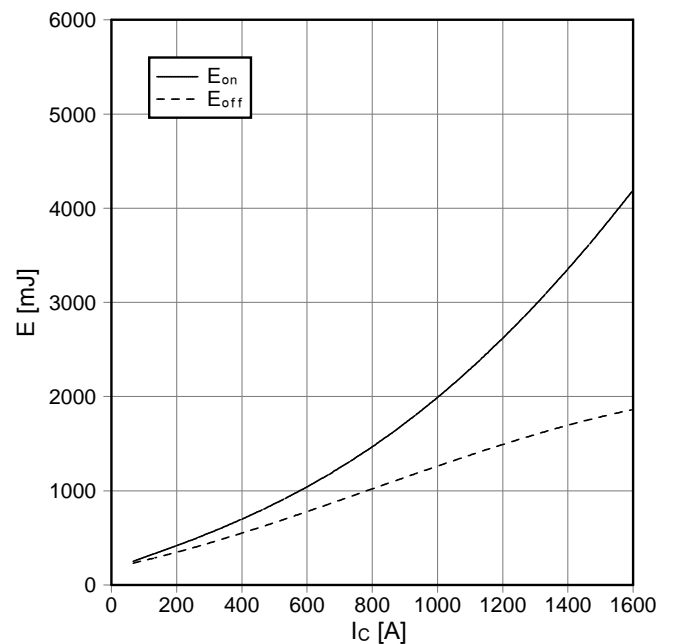
Ausgangskennlinienfeld IGBT-Wechselr. (typisch)
output characteristic IGBT-inverter (typical)
 $I_c = f(V_{CE})$
 $T_{vj} = 125^\circ\text{C}$



Übertragungscharakteristik IGBT-Wechselr. (typisch)
transfer characteristic IGBT-inverter (typical)
 $I_c = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



Schaltverluste IGBT-Wechselr. (typisch)
switching losses IGBT-inverter (typical)
 $E_{on} = f(I_c)$, $E_{off} = f(I_c)$
 $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 1,4\ \Omega$, $R_{Goff} = 1,8\ \Omega$, $V_{CE} = 1800\text{ V}$,
 $T_{vj} = 125^\circ\text{C}$, $C_{GE} = 150\text{ nF}$



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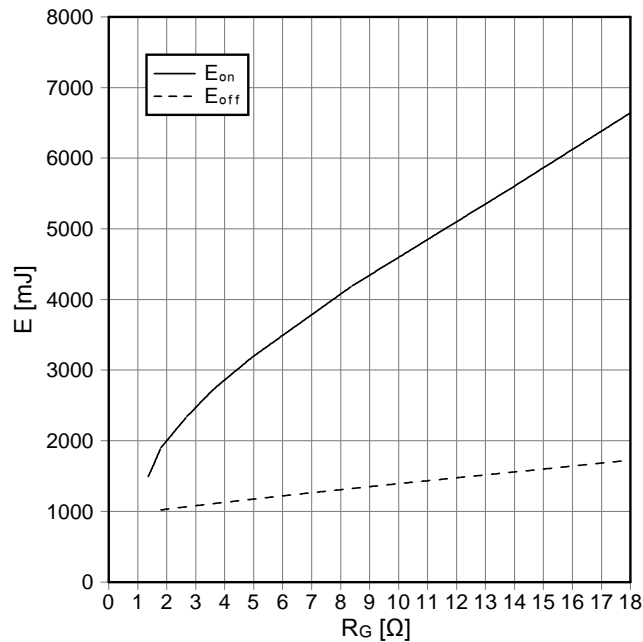
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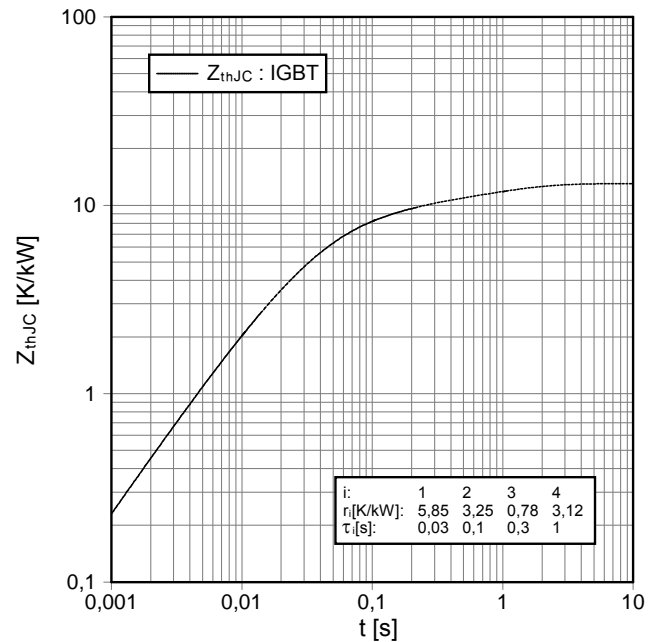


Vorläufige Daten preliminary data

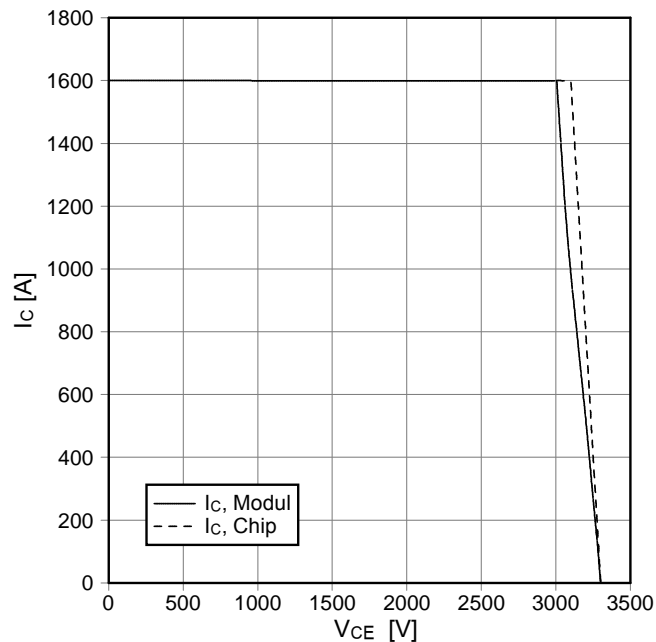
Schaltverluste IGBT-Wechselr. (typisch)
switching losses IGBT-Inverter (typical)
 $E_{on} = f(R_G)$, $E_{off} = f(R_G)$
 $V_{GE} = \pm 15\text{ V}$, $I_C = 800\text{ A}$, $V_{CE} = 1800\text{ V}$, $T_{vj} = 125^\circ\text{C}$,
 $C_{GE} = 150\text{ nF}$



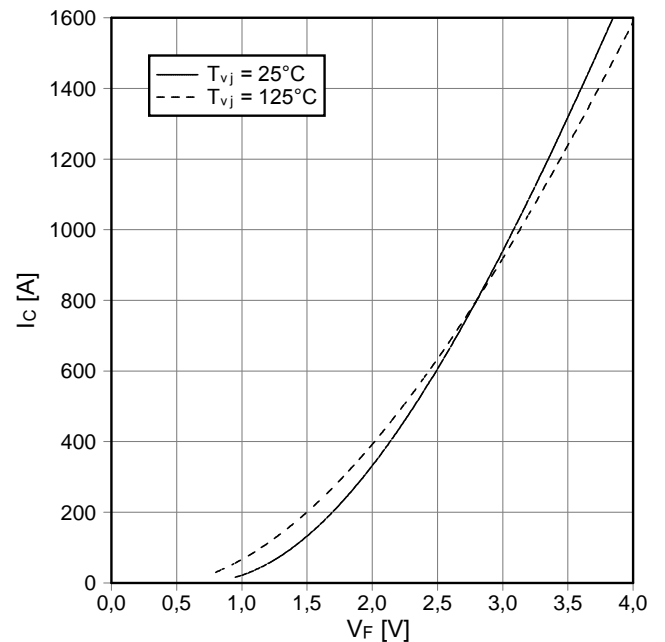
Transienter Wärmewiderstand IGBT-Wechselr.
transient thermal impedance IGBT-inverter
 $Z_{thJC} = f(t)$



Sicherer Rückwärts-Arbeitsbereich IGBT-Wr. (RBSOA)
reverse bias safe operating area IGBT-inv. (RBSOA)
 $I_C = f(V_{CE})$
 $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 1,8\ \Omega$, $T_{vj} = 125^\circ\text{C}$, $C_{GE} = 150\text{ nF}$



Durchlaßkennlinie der Diode-Wechselr. (typisch)
forward characteristic of diode-inverter (typical)
 $I_F = f(V_F)$



Technische Information/technical information

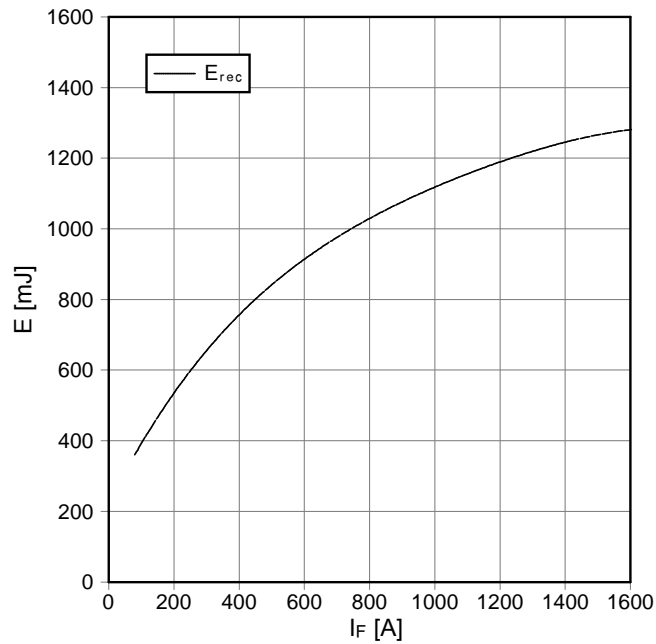
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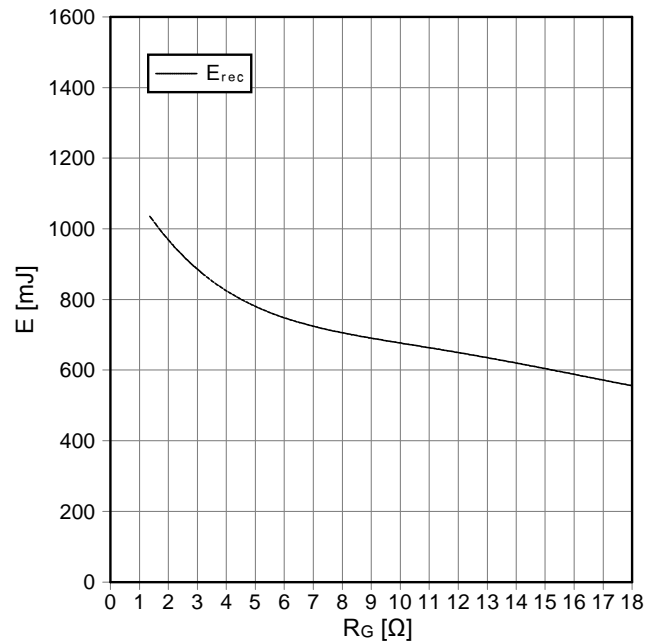


Vorläufige Daten preliminary data

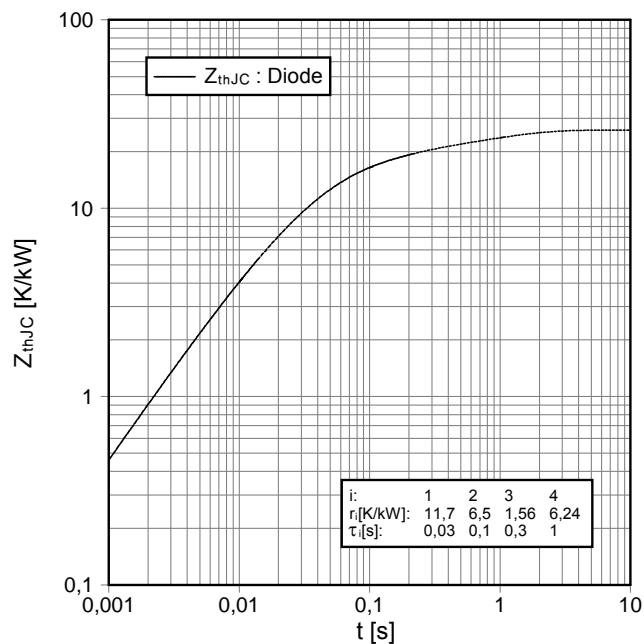
Schaltverluste Diode-Wechselr. (typisch)
switching losses diode-inverter (typical)
 $E_{rec} = f(I_F)$
 $R_{Gon} = 1,4 \Omega$, $V_{CE} = 1800 V$, $T_{vj} = 125^\circ C$



Schaltverluste Diode-Wechselr. (typisch)
switching losses diode-inverter (typical)
 $E_{rec} = f(R_G)$
 $I_F = 800 A$, $V_{CE} = 1800 V$, $T_{vj} = 125^\circ C$

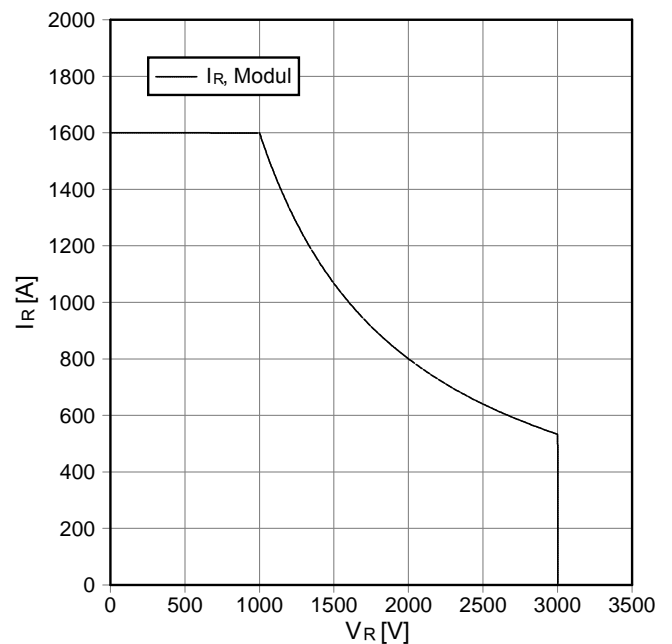


Transienter Wärmewiderstand Diode-Wechselr.
transient thermal impedance diode-inverter
 $Z_{thJC} = f(t)$



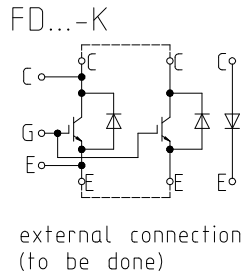
i:	1	2	3	4
r _i [K/kW]:	11,7	6,5	1,56	6,24
τ[s]:	0,03	0,1	0,3	1

Sicherer Arbeitsbereich Diode-Wechselr. (SOA)
safe operation area diode-inverter (SOA)
 $I_R = f(V_R)$
 $T_{vj} = 125^\circ C$

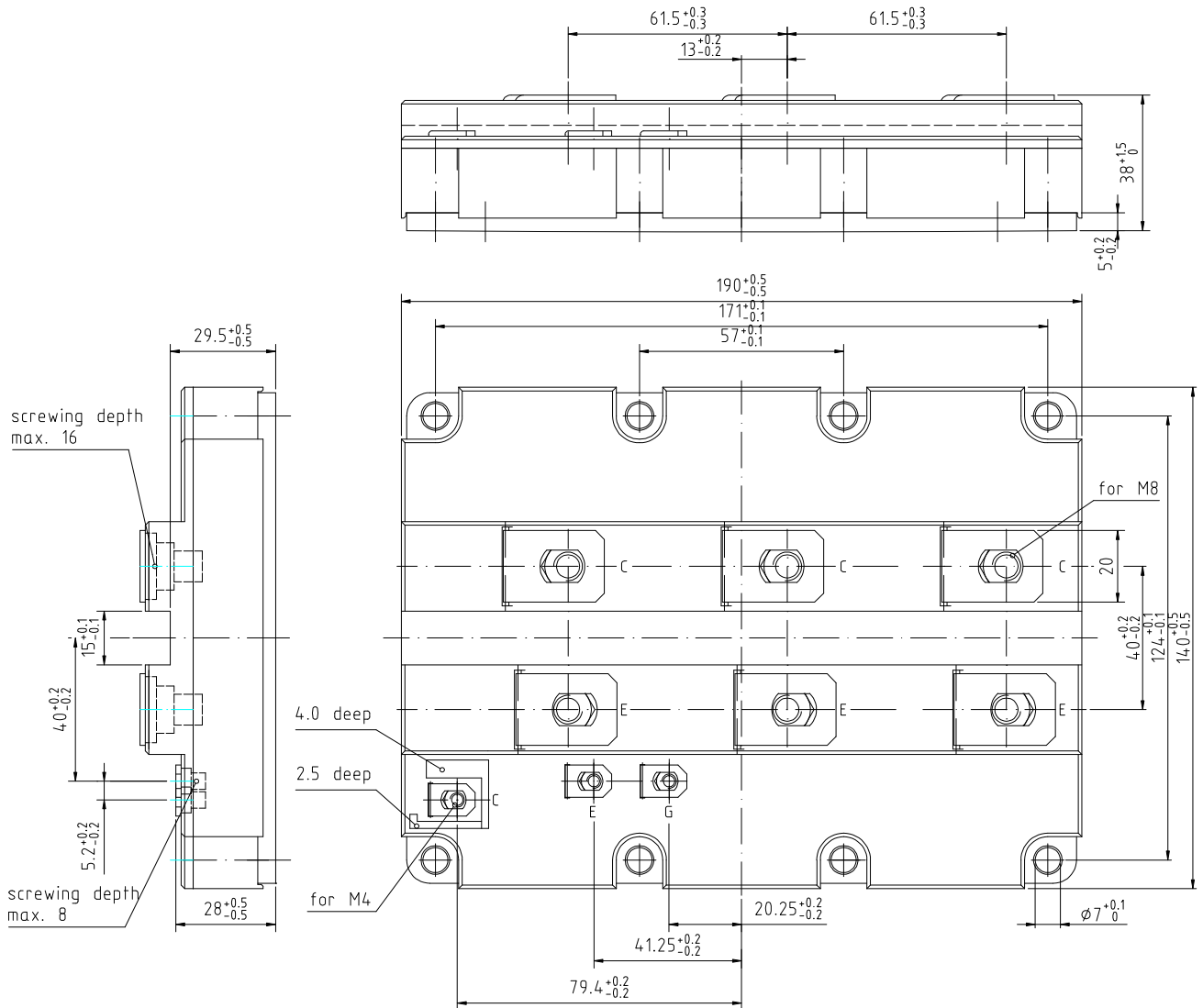


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Schaltplan/circuit diagram



Gehäuseabmessungen/package outlines



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